

FRED KD-1060UF.



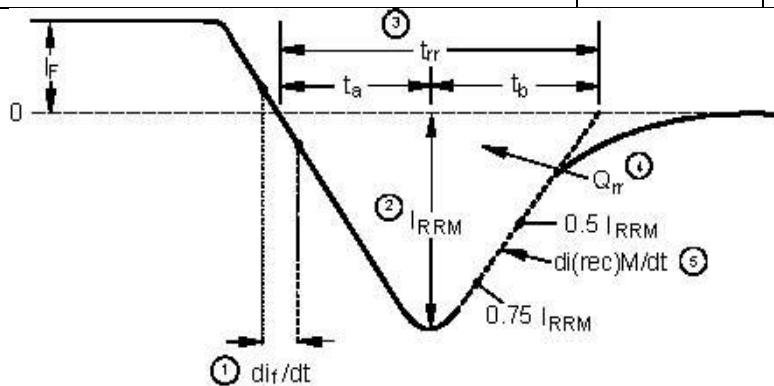
Rev.4. May. 2011



VSP-MIKRON

10A/600V. Die Size-88*88mil.

Electrical Characteristics	Symbol	Unit	Spec. limit	Die Sort
Breakdown Voltage @ $I_R=0,10\text{mA}$	V_B	V	600	620
Average Rectified Forward Current	$I_{F(AV)}$	A	10,0	-
DC Forward Voltage @ 25°C , $I_F=10,0\text{A}$	V_F	V	1,35	1,3
Maximum Reverse Current @ 25°C , $V_R=600\text{V}$ 125°C , $V_R=600\text{V}$	I_R	MA	0,010 0,500	0,009 0,450
Reverse Recovery Time, $I_F=1\text{A}$, $V_R=30\text{V}$, $dI_F/dt=100\text{A/uS.}$	t_{rr}	nS	65	70
Operating Junction Temperature	T_J	°C		175



1. di/dt - Rate of change of current through zero crossing

4. Q_{rr} - Area under curve defined by t_{rr} and I_{RRM}

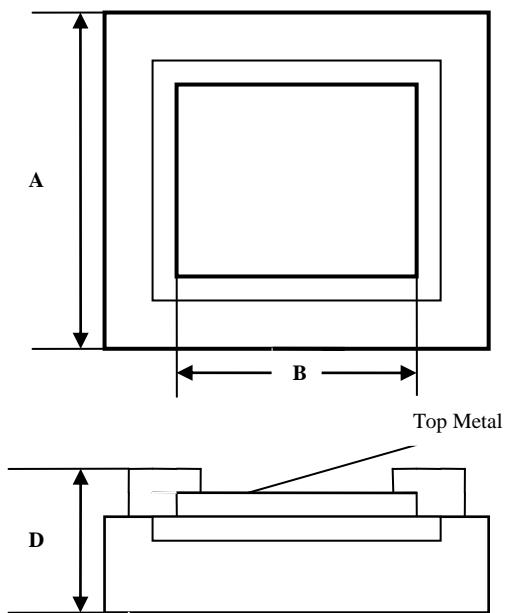
2. I_{RRM} - Peak reverse recovery current

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

3. t_{rr} - Reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through $0.75 I_{RRM}$ and $0.50 I_{RRM}$ extrapolated to zero current

5. $di_{(rec)}M/dt$ - Peak rate of change of current during t_b portion of t_{rr}

DIM	ITEM	µm
A_x A_y	Die Size	2240 2240
D	Thickness	350max.
Scribe line Width		60



Top metal: Al – for Wi

Backside metal: Ti-Ni-Ag – for Soldering.

www.vsp-mikron.com